

## YETDA INDUSTRY LTD.

# ${\bf 3mm~Red~Super~Bright~LED~Lamps~with~resistor~chip} \\ {\bf Q300HCHCR1H-12V}$

- 3 mm with InGaInP dice plus resistor chip •
- Encapsulated with Red diffused Lens package •
- \* Two leads •

#### **Absolute Maximum Ratings:**

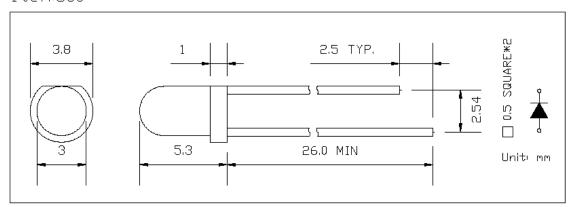
Parameter	Maximum Rating	Unit			
Peak Forward Current	120	mA			
Continuous Forward Current	30	mA			
Operating Temperature Range	-25°C to +80°C				
Storage Temperature Range	-35°C +85°C				
Lead Soldering Temperature	260°C for 3 seconds				
	1.6mm (0.063 inch) from body				

#### Electro-Optical Characteristics ( $Ta = 25^{\circ}C$ )

Parameter Radiant	Test Condition	Symbol	Min.	Тур.	Max.	Unit
Forward Voltage	If = 20Ma	Vf		12		V
Reverse Current	Vr = 5V	Ir			10	uA
Luminous Intensity	If = 20mA	Iv	150	250	350	mcd
Spectral Bandwidth	If = 20mA	Δλ		35		nm
Wavelength	If = 20mA	$\Lambda \mathbf{p}$		630		nm
		Λd	620	625	630	nm
Half View Angle	If = 20mA	2 <b>0</b> 1/2		80		deg

### **Package**

#### Item:300





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#### •Soldering:

1. Manual of soldering

The temperature of the iron tip should not be higher than 260 Cand

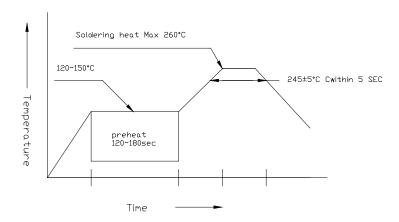
Soldering within 3 seconds per solder-land is to be observed

2. DIP soldering (Wave Soldering):

Preheating:120

°C~150°C within 5 sec.260°C(Max)

Gradual Cooling (Avoid quenching)



#### 3. Reflow Soldering

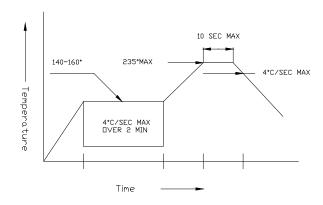
Preheating:140

°C~160°C±5°C, within 2 minutes.

Operation heating:235

§Q(Mxa)x) within 10 second

Gradual Cooling (Avoid quenching)



#### •Handling:

Care must be taken not to cause to the epoxy resin portion of Yetda LEDS while it is exposed to high temperature.

Care must be taken not rub the epoxy resin portion of Yetda LEDS with hard or sharp article such as the sand blast and the metal hook